| L Number | Hits | Search Text | DB | Time stamp |
|---|---|---|---|---|
| 1 | 1061 | 425/135.ccls. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/05 15:17 |
| - | 164 | 73/856.ccls. | USPAT | 2004/01/02 15:17 |
| - | 10 | 73/856.ccls. and mold | USPAT | 2001/02/26 09:38 |
| - | 5 | 73/856.ccls. and (mold molding) and (injection inject pressure) | USPAT | 2001/02/26 09:36 |
| - | 40553 | (injection pressure) and (molding mold ) and (device apparatus machine).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/02/26 09:42 |
| - | 9162 | (injection pressure) and (molding mold ) and (device apparatus machine) and (control controls).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/02/26 15:12 |
| - | 21 | ((injection pressure) and (molding mold ) and (device apparatus machine) and (control controls) and sensor and switch ).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 13:34 |
| - | 4 | ((injection pressure) and (molding mold ) and (device apparatus machine) and (control controls) and (force pressure strain) near4 sensor and switch ).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/02/26 10:00 |
| - | 10 | (injection pressure) and (molding mold ) and (device apparatus machine) and (control controls)and (subtractor substractor).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/02/27 13:41 |
| - | 2 | ((injection pressure) and (molding mold ) and (device apparatus machine) and (control controls)and (subtractor substractor)and (clamp clamping)).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/02/27 13:45 |
| - | 1 | ((injection pressure) and (molding mold ) and (device apparatus machine) and (control controls)and (subtractor substractor)and (clamp clamping)and sensor).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/02/27 13:45 |
| - | 26 | ("4131596" "4506321" "4714867" "5274316" "5313151" "5341452" "5362222" "5444341" "5583411").pn. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/23 17:05 |
| - | 27 | ("3864557" "3870445" "3878372" "3937776" "4094940" "4311446" "5232714" "5237509").pn. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/23 17:06 |
| - | 1 | ((injection pressure) and (molding mold ) and (device apparatus machine) and (control controls) and force near2 sensor and switch ).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:01 |
| - | 1 | ((injection pressure) near2 (molding mold ) near2 (device apparatus machine) and (control controls) and force near2 sensor).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:41 |
| - | 1 | ((injection pressure) near2 (molding mold ) near2 (device apparatus machine) and (control controls controller) and force near2 sensor).clm. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:06 |
| - | 17 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) near2 (device apparatus machine) and (control controls) and force near2 sensor) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2002/01/25 16:32 |

| - | | 10 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) near2 (device apparatus machine) and (control controls) and force near sensor) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:49 |
|---|---|---|---|---|---|
| - | | 1 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) near2 (device apparatus machine) and (control controls) and force near sensor) and platen | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:53 |
| - | | 0 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (control controls) and ((force near sensor) near4 platen)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:56 |
| - | | 0 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (control controls) and ((force near sensor) near6 platen)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:56 |
| - | | 1 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (control controls) and ((force near sensor) and platen)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:57 |
| - | | 0 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (clamp$4) near2 ((force near sensor) and platen)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:58 |
| - | | 1 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (clamp$4) and ((force near sensor) and platen)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:58 |
| - | | 0 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (clamp$4) near6 ((force near sensor) and platen)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:59 |
| - | | 88 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (clamp$4) near6 force and sensor and platen) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 14:59 |
| - | | 4 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (clamp$4) near6 force near4 sensor and platen) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/24 15:06 |
| - | | 4 | 425/$6.ccls. and ((injection pressure) near2 (molding mold ) and (clamp$4 near6 force) and (force near4 sensor) and platen) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/25 13:17 |
| - | | 19 | ("3870445" "5371450" "5912025" "5632222" "4131596") .pn. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/25 13:27 |
| - | | 19 | ("3870445" "5371450" "5912025" "5362222" "4131596") .pn. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2001/07/25 13:28 |
| - | | 172 | 73/856.ccls. | USPAT | 2002/01/25 16:32 |
| - | | 615 | 425/144.ccls. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 15:17 |
| - | | 699 | 318/560.ccls. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 15:18 |

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|---|---|---|---|---|
| - | 2 | 318/560.ccls. and (mold near clamp$5) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2002/01/25 16:34 |
| - | 187 | 73/856.ccls. | USPAT | 2004/01/02 15:17 |
| - | 644 | 425/144.ccls. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/05 15:17 |
| - | 818 | 318/560.ccls. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 15:19 |
| - | 809 | ((position displac$6 mov$5 distance separation) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and ((force pressure) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and (processor cpu computer calculat$4 control$4) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 15:43 |
| - | 10 | (((position displac$6 mov$5 distance separation) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and ((force pressure) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and (processor cpu computer calculat$4 control$4)) and (mold$4 near4 (clamp$4 grip$4 bind$4) near6 motor) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 15:38 |
| - | 189 | (((position displac$6 mov$5 distance separation) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and ((force pressure) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and (processor cpu computer calculat$4 control$4)) and (73/$6.ccls. 425/$6.ccls. 318/$6.ccls.) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 15:39 |
| - | 40 | (((position displac$6 mov$5 distance separation) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and ((force pressure) near4 (sens$4 detect$4 transduc$4 meter$4) near4 (clamp platen plate)) and (processor cpu computer calculat$4 control$4)) and ((mov$4 displac$4) near4 (plate? clamp$4 mold$4)) and ((stationary static non?mov$4 immobil$4) near4 (plate? clamp$4 mold$4)) | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 16:52 |
| - | 2 | 4832884.pn. | USPAT; EPO; JPO; DERWENT; IBM_TDB | 2004/01/02 16:52 |

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